

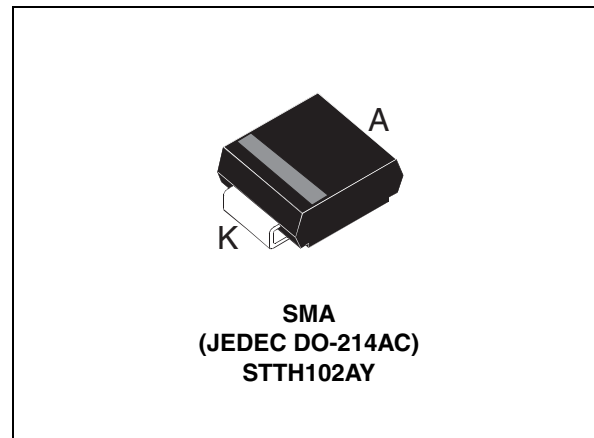
## Automotive high efficiency ultrafast diode

### Features

- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature
- ECOPACK<sup>®</sup>2 compliant component
- AEC-Q101 qualified

### Description

The STTH102-Y, which is using ST's new 200 V planar technology, is specially suited for switching mode base drive and transistor circuits. The device is also intended for use as a free wheeling diode in power supplies and other power switching applications for automotive.



**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	1 A
$V_{RRM}$	200 V
$T_j$ (max)	175 °C
$V_F$ (max)	0.78 V
$t_{rr}$ (max)	20 ns

# 1 Characteristics

**Table 2. Absolute rating (limiting values)**

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	200	V
$I_{F(AV)}$	Average forward current	$T_L = 148\text{ °C}$ $\delta = 0.5$	A
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ ms}$ sinusoidal	A
$T_{stg}$	Storage temperature range	-65 to +175	°C
$T_j$	Operating junction temperature range	-40 to +175	°C
dV/dt	Critical rate of rise of reverse voltage	10000	V/ $\mu$ s

**Table 3. Thermal resistance**

Symbol	Parameter	Value	Unit
$R_{th(j-l)}$	Junction to lead	30	°C/W

**Table 4. Static Electrical Characteristics**

Symbol	Parameter	Tests conditions	Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$		1	$\mu$ A
		$T_j = 125\text{ °C}$		1	25	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 700\text{ mA}$		0.90	V
			$I_F = 1\text{ A}$		0.97	
		$T_j = 125\text{ °C}$	$I_F = 1\text{ A}$	0.68	0.78	

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

2. Pulse test:  $t_p = 380\text{ }\mu$ s,  $\delta < 2\%$

To evaluate the conduction losses use the following equation:  $P = 0.65 \times I_{F(AV)} + 0.130 I_F^2(RMS)$

**Table 5. Dynamic electrical characteristics**

Symbol	Parameter	Tests conditions	Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25\text{ °C}$ $I_F = 0.5\text{ A}$ $I_{rr} = 0.25\text{ A}$ $I_R = 1\text{ A}$		12	20	ns
$t_{fr}$	Forward recovery time	$T_j = 25\text{ °C}$ $I_F = 1\text{ A}$ $di_F/dt = 50\text{ A/ms}$ $V_{FR} = 1.1 \times V_{Fmax}$		50		ns
$V_{FP}$	Forward recovery voltage	$T_j = 25\text{ °C}$ $I_F = 1\text{ A}$ $di_F/dt = 50\text{ A/ms}$		1.8		V

Figure 1. Average forward power dissipation versus average forward current

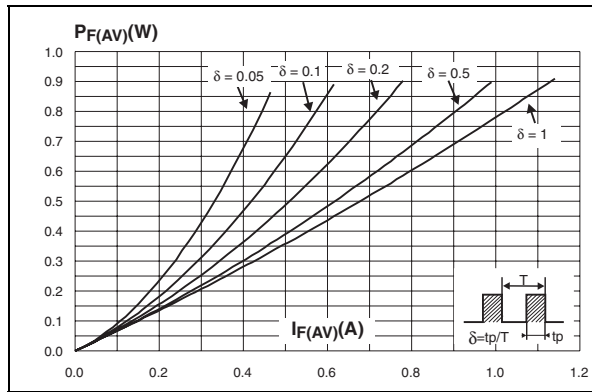


Figure 2. Average forward current versus ambient temperature (delta = 0.5)

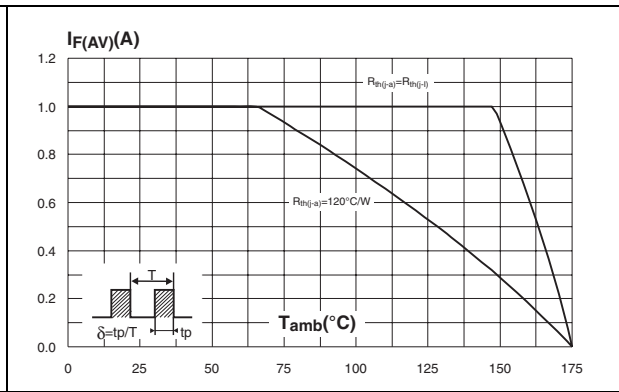


Figure 3. Relative variation of thermal impedance junction to ambient versus pulse duration

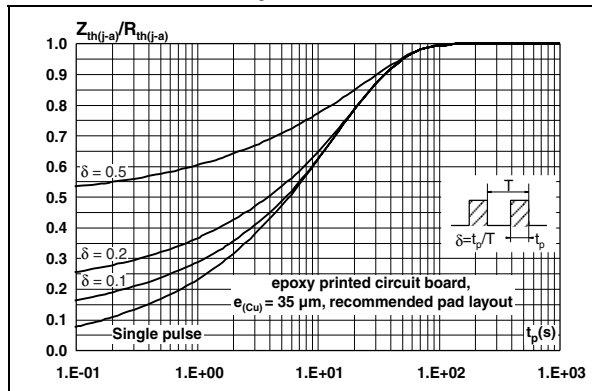


Figure 4. Forward voltage drop versus forward current

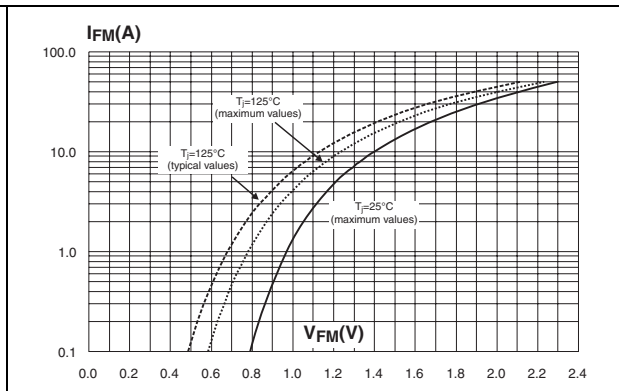


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

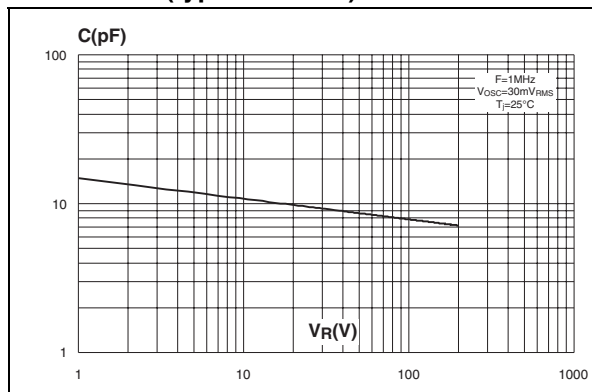


Figure 6. Reverse recovery time versus diF/dt (90% confidence)

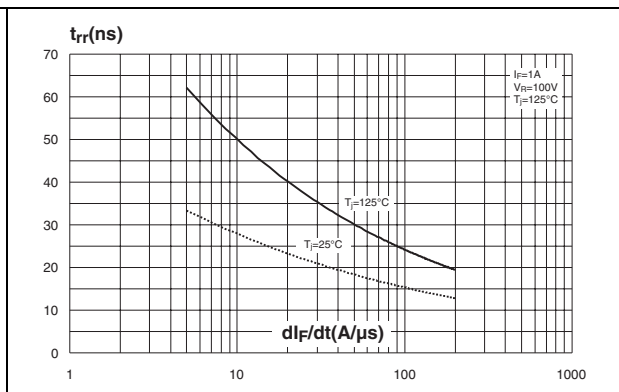


Figure 7. Peak recovery current versus  $di_F/dt$  (90% confidence)

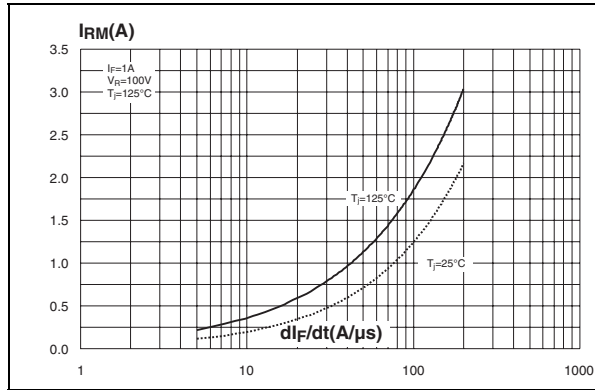


Figure 8. Reverse recovery charges versus  $di_F/dt$  (90% confidence)

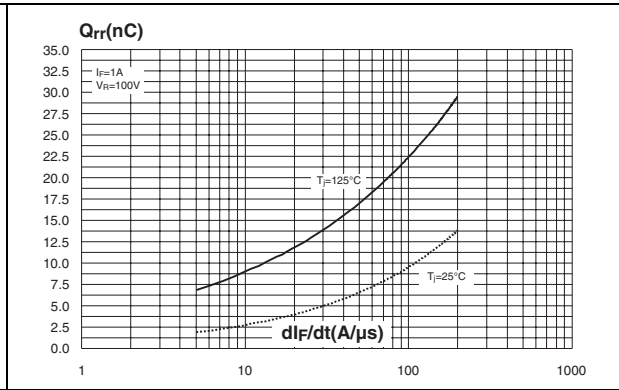


Figure 9. Relative variations of dynamic parameters versus junction temperature

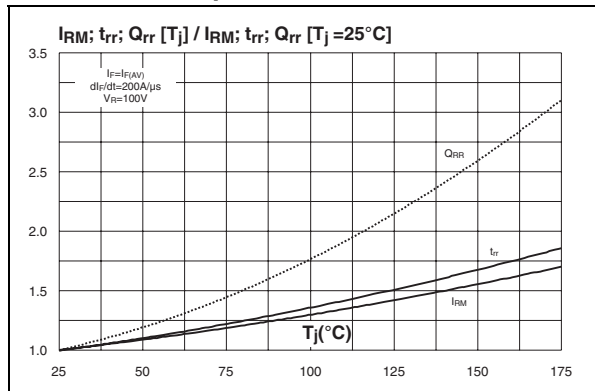
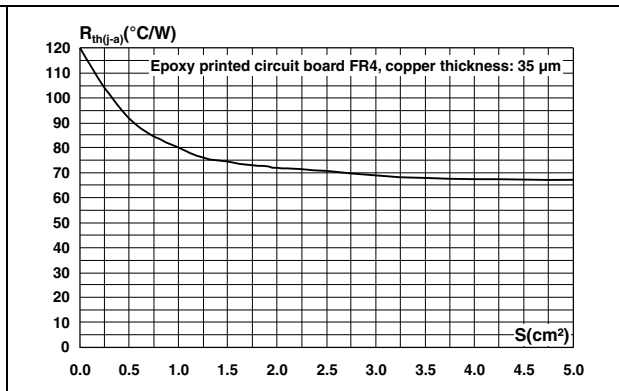


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead



## 2 Package information

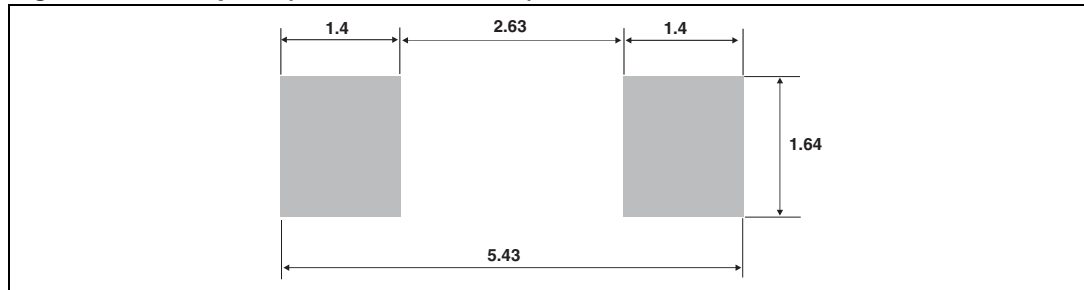
- Epoxy meets UL94 V0
- Lead-free packages

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**Table 6. SMA dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.094
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059

**Figure 11. Footprint (dimensions in mm)**



### 3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH102AY	U12Y	SMA	0.068 g	5000	Tape and reel

### 4 Revision history

Table 8. Revision history

Date	Revision	Changes
07-Nov-2011	1	Initial release.

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